




Applicable standard					
Rating	Operating Temperature range	-55 °C to +105°C (Note1)		Storage Temperature range	-10 °C to +60°C (Note2)
	Operating Humidity range	20% to 80%		Storage Humidity range	40% to 70% (Note2)
	Voltage	250 V AC/DC		UL C-UL Rating	29.9 V AC/DC
	Current	AWG 20 : 4 A/pin AWG 22 : 3A/pin AWG 24 : 2 A/pin AWG 26 : 1 A/pin			4A/pin
	Applicable Connector	DF62W-3S-2.2C(##)			Operating temperature range
Specifications					
Item		Test method		Requirements	QT AT
Construction					
General examination		Visually and by measuring instrument.		According to drawing.	X X
Marking		Confirmed visually.			X X
Electric characteristics					
Contact resistance		20mV MAX, 1mA (DC or 1000Hz).		30 mΩ MAX.	X -
Insulation resistance		500 V DC.		1000 MΩ MIN.	X -
Voltage proof		650 V AC for 1 min.		No flashover or breakdown.	X -
Mechanical characteristics					
Mechanical operation		30 times insertion and extraction.		1)Contact resistance: 30 mΩ MAX. 2)No damage, crack or looseness of parts.	X -
Vibration		Frequency 10 to 55 Hz, single amplitude 0.75 mm, at 10 cycles for 3 direction.		1)No electrical discontinuity of 1 μs. 2)No damage, crack or looseness of parts.	X -
Shock		490 m/s ² duration of pulse 11 ms at 3 times each for 3 both axial directions.			X -
Environmental characteristics					
Damp heat (Steady state)		Exposed at 40 ± 2°C , 90 to 95 %, 96 h. (After leaving the room temperature for 1-2h.)		1)Contact resistance: 30 mΩ MAX. 2)Insulation resistance: 500 MΩ Min. 3)No damage, crack or looseness of parts.	X -
Rapid change of temperature		Temperature -55°C→ +105°C Time 30min→ 30min Under 5 cycles. (The transferring time of the tank is 2-3 min) (After leaving the room temperature for 1-2h.)		1)Contact resistance: 30 mΩ MAX. 2)Insulation resistance: 1000 MΩ Min. 3)No damage, crack or looseness of parts.	X -
Dry heat		Exposed at +105°C,96h.			X -
Cold		Exposed at -55°C,96h.			X -
Remarks Note 1: Include the temperature rising by current. Note 2: Apply to the condition of long term storage for unused products before mounted on PCB. After mounted on PCB, operation temperature and humidity range is applied for interim storage during transportation.					
	Count	Description of revisions	Designed	Checked	Date
△1	1	DIS-H-00006334	HT. SATO	SZ. ONO	20200907
Unless otherwise specified, refer to IEC 60512.				Approved	HS. OKAWA
				Checked	SZ. ONO
				Designed	HT. SATO
				Drawn	HT. SATO
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			Drawing No.	ELC-364586-20-00	
HS	Specification sheet		Part No.	DF62W-3P-2. 2DSA (20)	
	HIROSE ELECTRIC CO., LTD.		Code No.	CL544-1021-0-20	△ 1/2

Specifications					
Item	Test method	Requirements	QT	AT	
Resistance to Soldering heat 	1) Solder bath method Soldered at solder temperature 260°C for in immersion , duration, 10 s. 2) Manual soldering Soldering iron temperature:300°C, Soldering time: 3s. No strength on contact.	Such as impaired function ,no deformation of case of excessive looseness of the terminals.	X	—	
Solderability	Soldered at solder tempereture 245°C for in immersion,duration,5s.	A new uniform coating of solder shall cover minimum of 95% of the surface being immersed.	X	—	
Sealing	Exposed at a depth of 1m for 0.5h.	No water penetration inside connector.	X	—	
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	Specification sheet	Part No.	DF62W-3P-2. 2DSA (20)		
	HIROSE ELECTRIC CO., LTD.	Code No.	CL544-1021-0-20		2/2